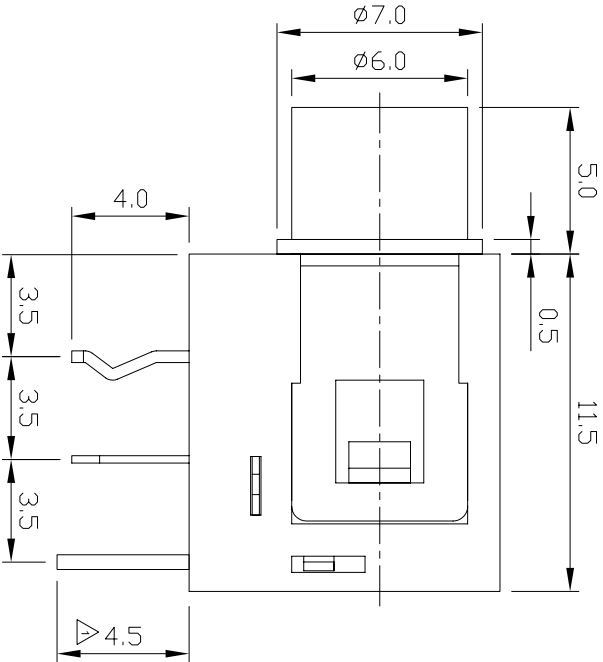
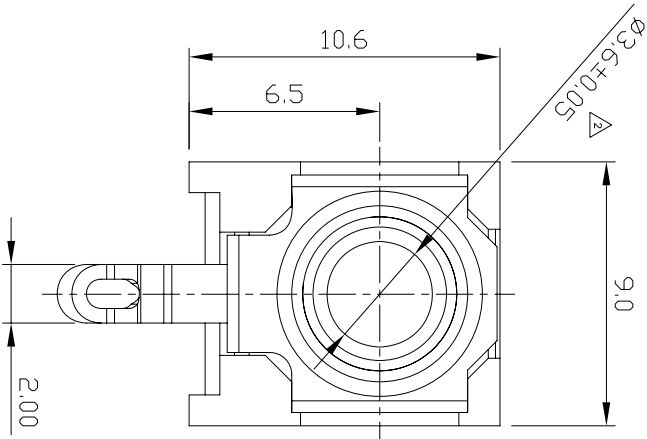
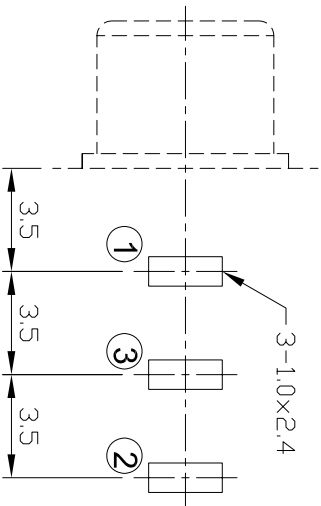




HISTORY		DATE	ECON NO.	REV.	REVISION	SIGN.
X COUNT	1	23APR08	N200912006	B	修改PIN腳尺寸，4.0mm改為4.5mm。	Chis
Δ	x1	29DEC09	N200912006	C	修改孔內尺寸。	Chis
Δ	x2	14FEB11*		D	修改線路及LAYOUT圖樣，以便與實物相符。	Chis



PCB LAYOUT
(BOTTOM VIEW) Δ

5	HOUSING	1	PBT		BLACK
4	BUSHING	1	BRASS	NICKEL	
3	TIP TERM	1	P.B.S 0.25THK	TIN	
2	RING TERM	1	BRASS 0.5THK	TIN	
1	GROUND TERM	1	C.R.S 0.4THK	TIN	
NO	PART NAME	Q'TY	MATERIAL	PLATED	REMARK

® LIH SHENG PRECISION INDUSTRIAL CO., LTD.					
TOLERANCE		Material	PART NAME		PHONE JACK
X.	± 0.5	Thickness	PART NO.	LJE3513A-3RT	
X.X	± 0.3	Disposal	DATE	10/04/00'	
X.XX	± 0.15	UNIT	SCALE	DRAW	CHECK
		mm	4:1	Chris	Ken
				Chris	Ken

